

TECHNICAL DATA SHEET



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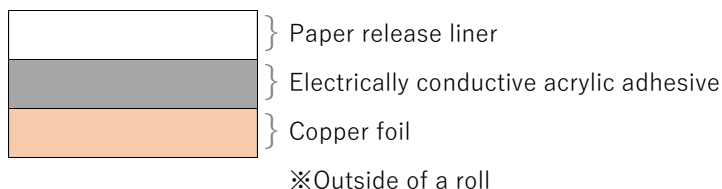


4F46A4 E Color & Comfort

Electrically conductive copper foil adhesive tape

DAITAC® E20CU

■ Construction



■ Characteristics

- ✓ Tape thickness is 20 μm .
- ✓ Excellent electrical conductivity in thickness direction.
- ✓ Excellent adhesion
- ✓ Product does not use the 6 restrictive substances of the RoHS Directive.

■ Applications

- ✓ For EMI shielding of electronic equipment.

■ Properties

Test item	Condition	Substrate	Unit	E20CU
Thickness	Except release liner	-	μm	20
180 deg. peel strength	23°C, 1hr	SUS (hairline)	N/25mm	10
Electrical resistance	Pressure method	Copper foil	$\Omega/6.25\text{cm}^2$	0.02
	Attached method	Copper foil	$\Omega/6.25\text{cm}^2$	0.08
Static shear	70°C, 0.1kg	SUS (hairline)	hr	24 <

■ **Size** 1,000mm in max width 50m in length

DIC Corp.

Composite Materials Product Div.

https://www.dic-global.com/en/products/adhesive_tapes

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